

Title (en)

SEED TREATMENT FORMULATIONS

Title (de)

SAATGUTBEHANDLUNGSFORMULIERUNGEN

Title (fr)

FORMULATIONS POUR TRAITEMENT DE SEMENCES

Publication

**EP 2961274 A4 20160907 (EN)**

Application

**EP 14753685 A 20140220**

Priority

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- US 2014017360 W 20140220

Abstract (en)

[origin: WO2014130653A1] The present invention generally relates to aqueous seed treatment formulations comprising from about 0.2 to about 15 % of at least one pesticidal agent, from about 0.1 to about 0.45 % of at least one graft copolymer, at least one polyvinyl alcohol (PVA), and from about 5 to about 30 % of at least one plasticizer. The present invention also relates to aqueous seed treatment formulations wherein the pesticidal agents are clothianidin, metconazole, and metalaxylyl.

IPC 8 full level

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CPC (source: EP)

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Citation (search report)

- [X] US 2009143447 A1 20090604 - ARTHUR KAREN S [US], et al
- [X] CN 102090398 A 20110615 - SHANGHAI ACAD AGRI SCIENCES, et al
- See references of WO 2014130653A1

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DOCDB simple family (publication)

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